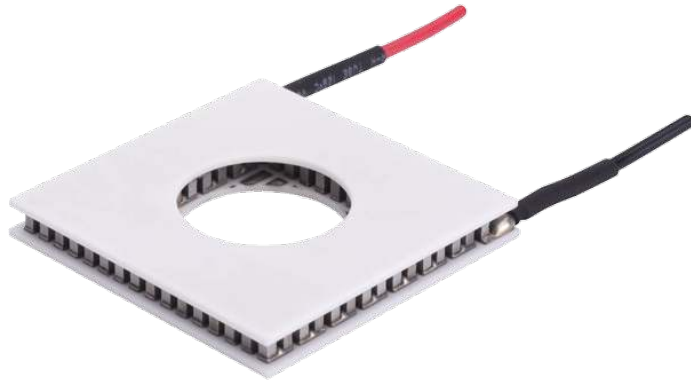


**Annular SH Series Thermoelectric Cooler**

The SH10-95-06-L-EP-W4.5 is an annular-style thermoelectric cooler. The hot and cold side ceramics have a circular hole in the center to accommodate light protrusion for optics, mechanical fastening or temperature probe. It has a maximum Qc of 19.1 Watts when  $\Delta T = 0$  and a maximum  $\Delta T$  of 70.5 °C at Qc = 0.

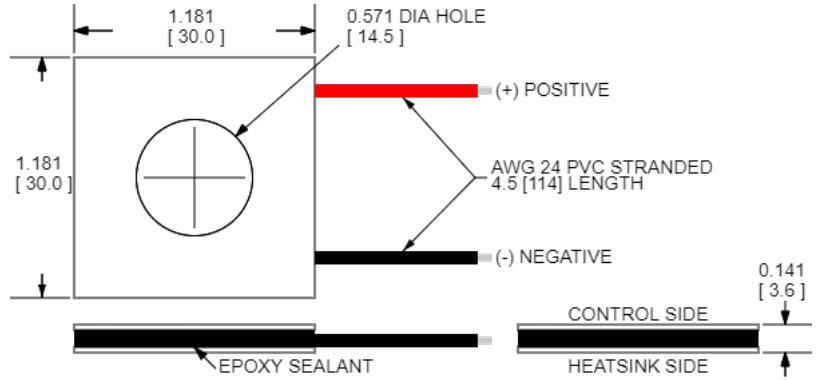


**Features**

- Center Hole
- Precise Temperature Control
- No sound or vibration
- Reliable solid-state
- DC Operation
- RoHS-compliant

**Applications**

- Thermoelectric Coolers for Reagent Storage
- Thermoelectric Coolers for Handheld Cosmetic Lasers
- Cooling for Centrifuges
- Heads-Up Displays, Imaging Sensors
- Peltier Cooling for Machine Vision

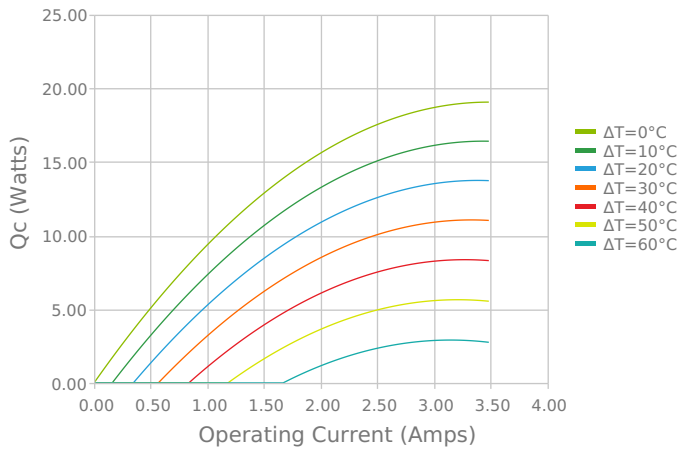


CERAMIC MATERIAL: Al<sub>2</sub>O<sub>3</sub>  
 SOLDER CONSTRUCTION: 138°C, BiSn  
 INCHES [ MM ]  
 Note: Allow 0.020 in [0.5 mm] around perimeter of the thermoelectric cooler and lead wire attachment to accommodate sealant

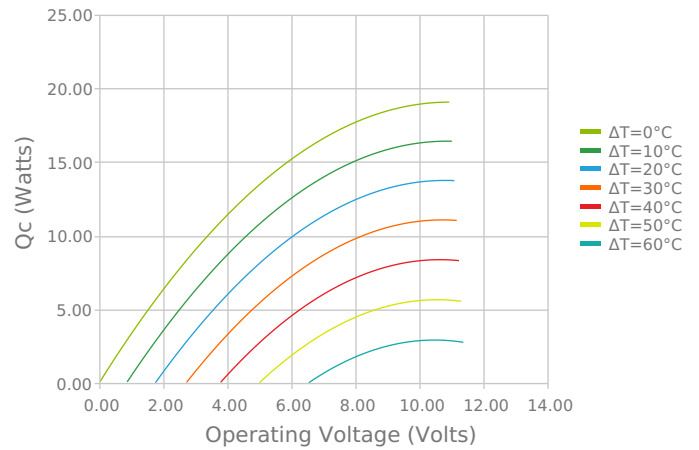
**ELECTRICAL AND THERMAL PERFORMANCE**

For maximum performance, be sure to orient the CONTROL side of the TEC against the application to be managed and the HEATSINK side against the heat sink or other heat rejection method. The CONTROL side is always opposite the side with lead attachments. Lead attachment is a passive heat loss and less impactful if located on the side that attaches to the heat exchanger.

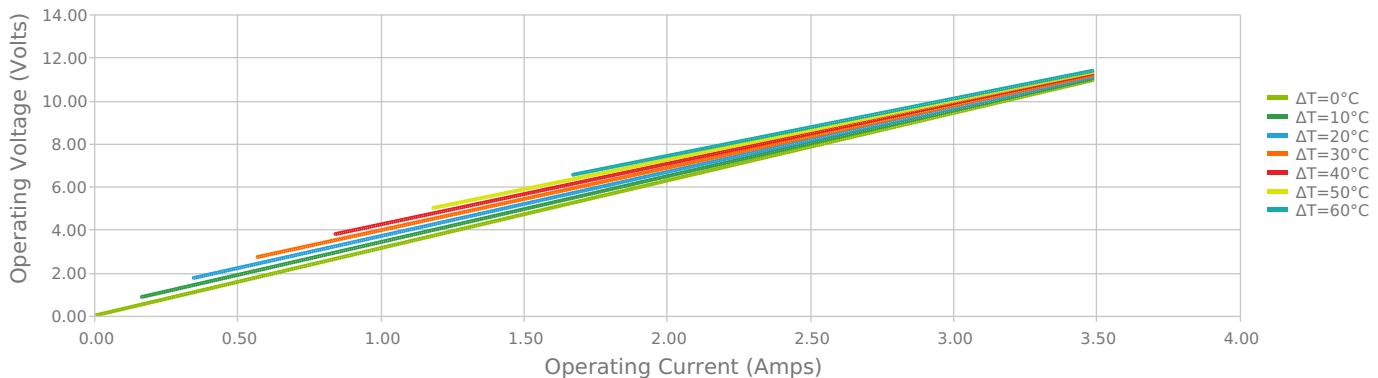
Heat Pumped at Cold Side  
 Thot = 27 °C



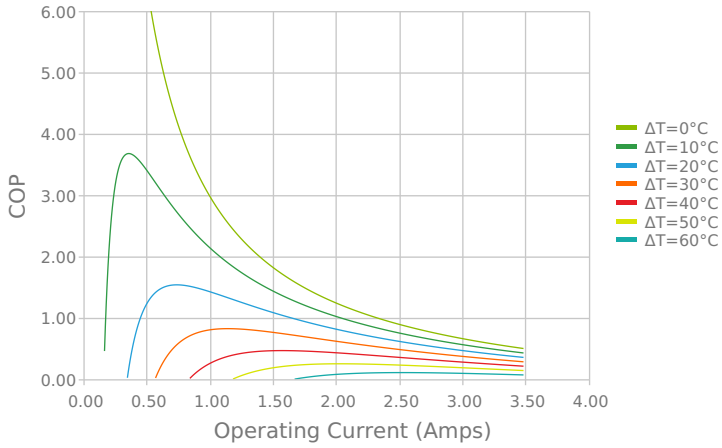
Heat Pumped at Cold Side  
 Thot = 27 °C



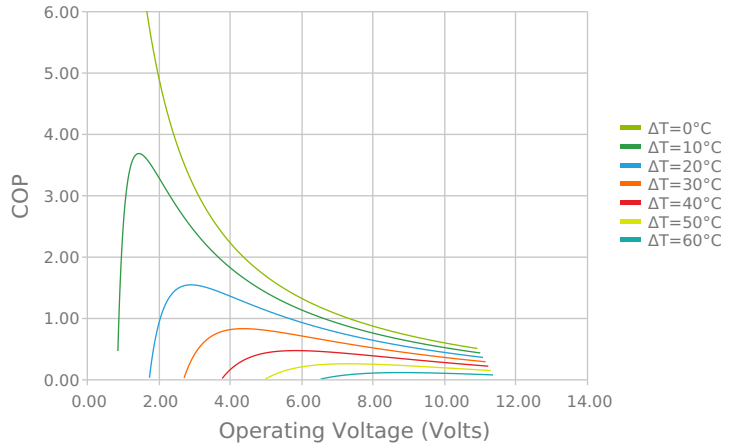
Current vs Voltage (I vs V)  
 Thot = 27 °C



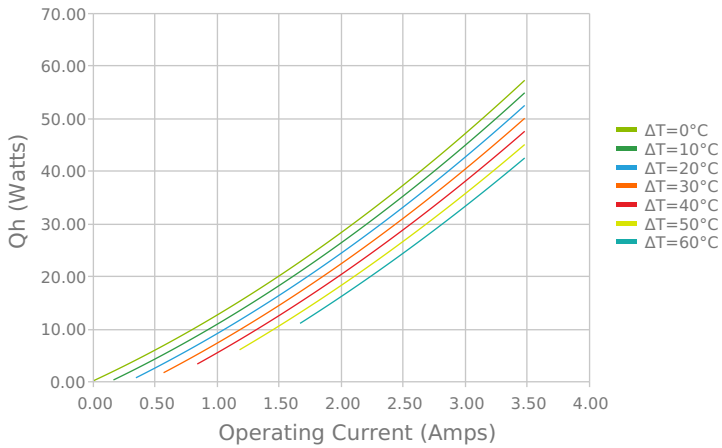
Coefficient of Performance (COP = Qc/Pin)  
 Thot = 27 °C



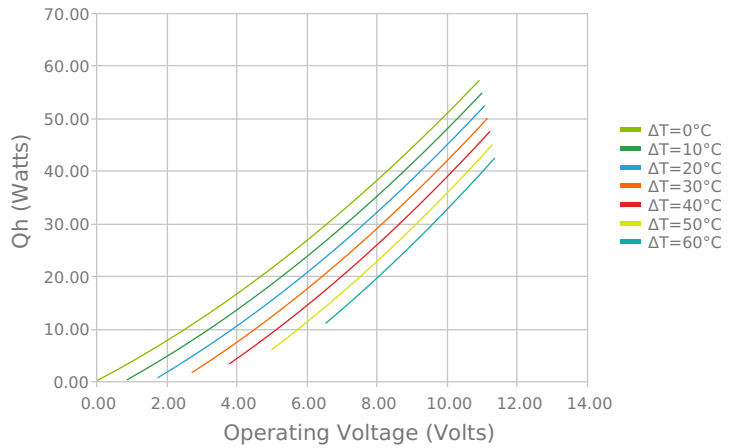
Coefficient of Performance (COP = Qc/Pin)  
 Thot = 27 °C



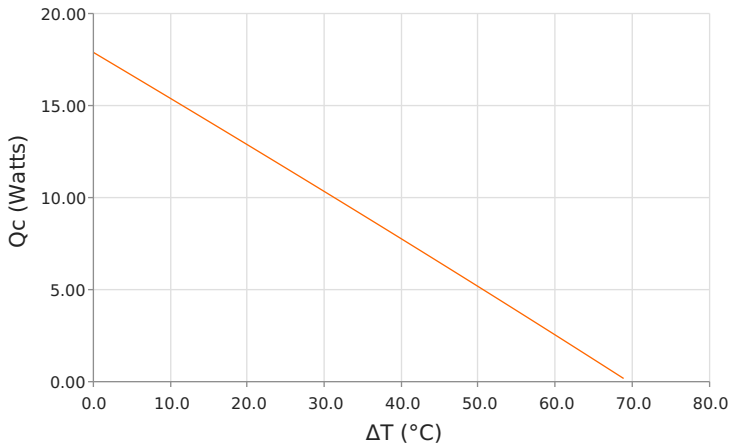
Total Heat Dissipated at Hot Side (Qh=Qc+Pin)  
 Thot = 27 °C



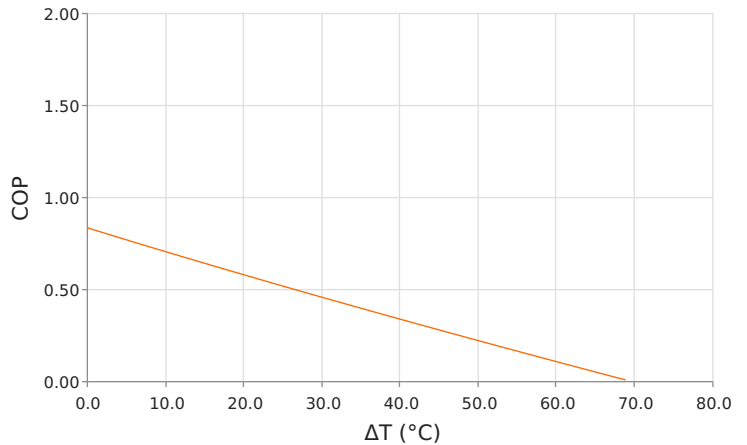
Total Heat Dissipated at Hot Side (Qh=Qc+Pin)  
 Thot = 27 °C



Heat Pumped at Cold Side (Qc)  
 Thot = 27 °C | Current = 2.6 Amps



Coefficient of Performance (COP = Qc/Pin)  
 Thot = 27 °C | Current = 2.6 Amps



## SPECIFICATIONS\*

Hot Side Temperature	27.0 °C	35.0 °C	50.0 °C
<b>Qcmax (<math>\Delta T = 0</math>)</b>	19.1 Watts	19.6 Watts	20.7 Watts
<b><math>\Delta T_{max}</math> (<math>Q_c = 0</math>)</b>	70.5°C	73.5°C	78.8°C
<b>I<sub>max</sub> (I @ <math>\Delta T_{max}</math>)</b>	3.1 Amps	3.1 Amps	3.0 Amps
<b>V<sub>max</sub> (V @ <math>\Delta T_{max}</math>)</b>	10.4 Volts	10.8 Volts	11.5 Volts
<b>Module Resistance</b>	3.14 Ohms	3.27 Ohms	3.51 Ohms
<b>Max Operating Temperature</b>	80 °C		
<b>Weight</b>	9.0 gram(s)		

\* Specifications reflect thermoelectric coefficients updated March 2020

## FINISHING OPTIONS

Suffix	Thickness	Flatness / Parallelism	Hot Face	Cold Face	Lead Length
L	3.581 ±0.254 mm 0.141 ± 0.0100 in	0.004 mm / 0.004 mm 0.00015 in / 0.00015 in	Lapped	Lapped	114.3 mm 4.50 in

## SEALING OPTIONS

Suffix	Sealant	Color	Temp Range	Description
EP	Epoxy	Black	-55 to 150°C	Low density syntactic foam epoxy encapsulant

## NOTES

1. Max operating temperature: 80°C
2. Do not exceed I<sub>max</sub> or V<sub>max</sub> when operating module
3. Reference assembly guidelines for recommended installation
4. Solder tinning also available on metallized ceramics

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